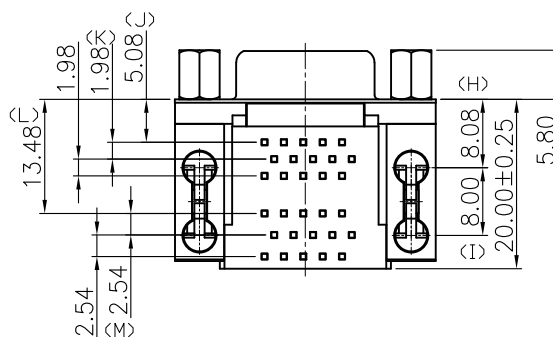
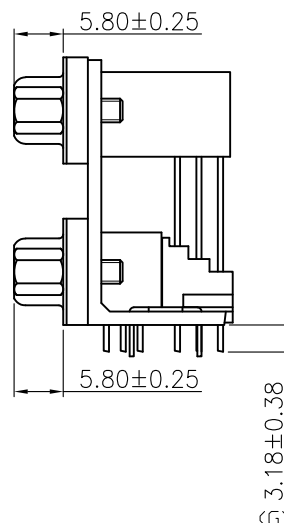




INSPECTION DIMENSION:(A)~(M)

1. MATERIAL:

Terminal:Copper Alloy.

Boardlock:Copper Alloy.

Bracket: Zinc Alloy.

Screw: Copper Alloy.

Terminal:Gold Plated over Nickel at Contact Area.

Tin Plated over Nickel at Solder Ared.

Shell:Nickel Plated.

Boardlock: Tin Plated.

Bracket:Nickel Plated.

Screw:Nickel Plated.

3. This Product is LEAD-FREE & RoHS Compliance Product.

1. D-SUB

1.1 Voltage: 250 VAC(RMS) Max.

1.2 Current Rating: 3 Ampere per Contact

1.3 Contact Resistance: 25 Milliohms Max.

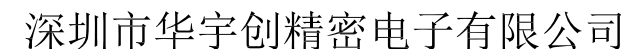
1.4 Insulation Resistance: 5000 Megohms Min.

1.5 Dielectric Withstanding Voltage: 1000V AC(RMS)

1.6 Total Mating Force: 6.0 Kgf Max.

1.7 Total Unmating Force: 1.2 Kgf Min.

1.8 Operating Temperature: -55°C to $+85^{\circ}\text{C}$



TOLERANCE:		DRAWN BY : 陈一鸣	DATE : 2014-02-23	PART NAME: HDR15母对HDR15母 铆锁5.08 间距19.0	
X.X ±0.30	X.XX ±0.25				
X.XXX ±0.15		CHECKED BY:	DATE :	PART NO.	HYCW56-VGA30B-195B
X.* ±2*	X.X* ±0.5*	马跃	2014-02-23	MOLD NO.	
				APPROVED BY:	DATE :
UNIT: mm	[inch]	邱国夷	2014-02-23	SHEET NO.	1 OF 1
SCALE:1:1	SIZE: A4				